



BZT52HC5V6WFQ - BZT52HC18WFQ

SURFACE MOUNT ZENER DIODE

Features

- Flat Lead Package Design for Low Profile and High Power Dissipation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BZT52HC5V6WFQ BZT52HC18WFQ are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish—Matte Tin Annealed over Copper Alloy Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

SOD123F (Type B)



Top View



Bottom View

Ordering Information (Note 4)

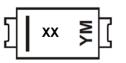
Part Number	Compliance	Case	Packaging
BZT52HC5V6WFQ-7	Automotive	SOD123F (Type B)	3000/Tape & Reel
BZT52HC18WFQ-7	Automotive	SOD123F (Type B)	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



XX = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: I – 2021) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2018		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	F		-	J	К	L	М	N	0	Р	R	S
N (1								A	Son	Oct	Nev	Dee
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Forward Voltage (Note 5)	@ I _F = 10mA	V _F	0.9	V
Forward Current		I _F	250	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	375	mW
Power Dissipation (Note 7)	PD	830	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ ext{ heta}JA}$	330	°C/W
Thermal Resistance, Junction to Ambient Air (Note 7)	R ₀ JA	150	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150	°C

Notes: 5. Short duration pulse test used to minimize self-heating effect.

Device mounted on FR-4 PCB with molimum recommended pad layout, as shown in Diodes Incorporated's Suggested Pad Layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.
Device mounted on FR-4 PCB with mounting pad for cathode 1cm².

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

		Zener Voltage Range (Note 8)		Maximum Zener Impedance (Note 9)			Temperature Coefficient		Total Capacitance	Maximum Reverse Current (Note 8)		
Type Number	Marking Codes		D I _{ZT}	I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK}	I _{ZK}	T _C @ I _{ZT}		C _T @ f = 1MHz, V _R = 0V	I _R	@ V _R
		Min (V)	Max (V)	mA	Ω mA		Min (mV/°C)	Max (mV/°C)	Max (pF)	μA	v	
BZT52HC5V6WFQ	W9	5.2	6.0	5	40	400	1	-2.0	2.5	300	1	2
BZT52HC18WFQ	WL	16.8	19.1	5	20	170	1	12.4	16.0	70	0.05	12.6

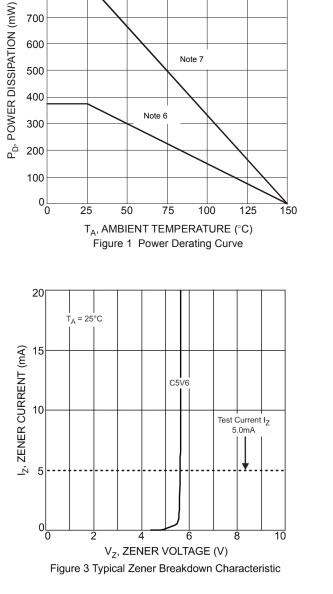
Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. f = 1kHz.

600 500

900

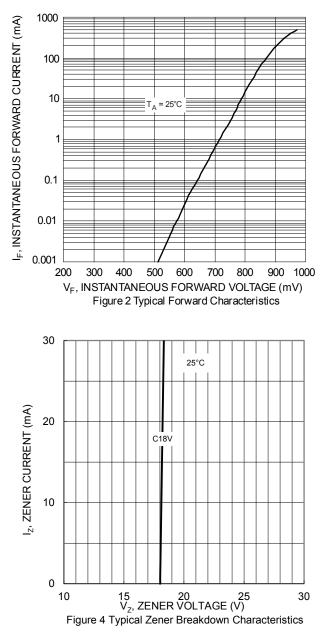
800

700



Note 7

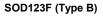
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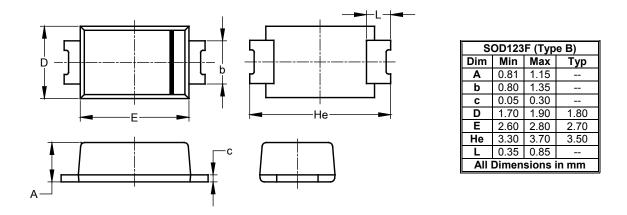




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

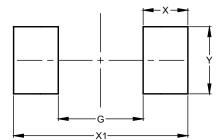




Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
G	1.90
Х	1.00
X1	3.90
Y	1.50



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